

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: )  
)  
Appl. No. : 10/823,970 ) Confirmation No. 5318  
Applicant : OGAWA, et al. )  
Filed : 13 April 2004 )  
Art Unit : 2818 )  
Examiner : Hoang, Quoc Dinh )  
Attorney )  
Docket No. : SPSN-AF01215 )  
)  
For: SEMICONDUCTOR DEVICE HAVING )  
A PAD METAL LAYER AND A LOWER METAL )  
LAYER THAT ARE ELECTRICALLY )  
COUPLED, WHEREAS APERTURES ARE )  
FORMED IN THE LOWER METAL LAYER )  
BELOW A CENTER AREA OF THE PAD )  
METAL LAYER )  
\_\_\_\_\_ )

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

AMENDMENT AND RESPONSE AND TO OFFICE ACTION

Dear Sir:

In response to the Office Action dated April 4, 2008, Applicants respectfully request reconsideration of the above-identified patent application. Please consider the following amendments and remarks for allowance of the above-identified patent application. Immediately after this transmittal page are Amendments to the Claims, included in a complete listing of the claims, followed by Applicant Argument (or Remarks).

I hereby certify that this  
correspondence is being  
electronically transmitted to the  
USPTO via EFS on the date shown  
below:  
July 7<sup>th</sup>, 2008  
/Christina Holland/  
Christina Holland